

No. EU265089254US U.S. Express M. GROUP 12003 Attorney Docket No.: AM-5120

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

**GROUP ART UNIT: 176** 

EXAMINER: K. A. Moore

IN RE APPLICATION OF: Jennifer Y. Sun et al.

SERIAL NO.: 10/075,967

FILED: February 14, 2002

FOR: YTTRIUM OXIDE BASED SURFACE COATING

FOR SEMICONDUCTOR IC PROCESSING

**VACUUM CHAMBERS** 

Attorney Docket No.:

AM-5120

Date: August 6, 2003

## AMENDMENT "A" UNDER 37 CFR § 1.111

Hon. Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450

Sir:

This Amendment "A" is in response to the Office Action mailed May 6, 2003, having a shortened statutory period for response of August 6, 2003.

Claims 1 - 12 are pending in the application.

Claims 6 - 12 are withdrawn from consideration under a restriction requirement.

## **CERTIFICATE OF MAILING UNDER 37 CFR § 1.10**

I hereby certify that this paper is being deposited with the U.S. Postal Service on the date shown below with sufficient postage as U.S. EXPRESS MAIL NO. EU265089254US in an envelope addressed to: Mail Stop Non-Fee Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Date: August 6, 2003

U.S. Express Ma. No. EU265089254US Attorney Docket No.: AM-5120

Claim 1 is rejected under 35 USC § 102(b) as being anticipated by Japanese Patent Publication No. 03287797, to Inazawa et al.

Claim 2 is rejected under 35 USC § 103(a) as being unpatentable over Inazawa et al., as applied to Claim 1, and further in view of U.S. Patent No. 5,798,016, to Oehrlein et al.

Claims 2 and 3 are rejected under 35 USC § 103(a) as being unpatentable over Inazawa et al., as applied to Claim 1, and further in view of U.S. Patent Publication No. 2001/0003271, to Otsuki.

Claim 4 is rejected under 35 USC § 103(a) as being unpatentable over Inazawa et al., as applied to Claim 1, and further in view of Japanese Patent Publication No. 2001023908, to Okada et al.

Claim 5 is rejected under 35 USC § 103(a) as being unpatentable over Inazawa et al., as applied to Claim 1, and further in view of U.S. Patent No. 6,521,046, to Tanaka et al.

Please amend the application as follows: